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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/576,416	11/29/2006	Kazumi Naito	Q78150	3434
23373 7590 09/15/2010 SUGHRUE MION, PLLC 2100 PENNSYLVANIA AVENUE, N.W.			EXAMINER	
			CRAWFORD, LATANYA N	
SUITE 800 WASHINGTON, DC 20037		ART UNIT	PAPER NUMBER	
			2813	
			NOTIFICATION DATE	DELIVERY MODE
			09/15/2010	ELECTRONIC

## Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

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## Advisory Action Before the Filing of an Appeal Brief

	Application No.	Applicant(s)	
Application No.		Applicant(s)	
10/576,416		NAITO ET AL.	
Examiner		Art Unit	
	LAdillilei	Artonic	
	LATANYA CRAWFORD	2813	

--The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

THE REPLY FILED 25 August 2010 FAILS TO PLACE THIS APPLICATION IN CONDITION FOR ALLOWANCE.
1. Q The reply was filed after a final rejection, but prior to or on the same day as filing a Notice of Appeal. To avoid abandonment of thi application, applicant must timely file one of the following replies: (1) an amendment, affidavit, or other evidence, which places the application in condition for allowance; (2) a Notice of Appeal (with appeal fee) in compliance with 37 CFR 41.31; or (3) a Request for Continued Examination (RCE) in compliance with 37 CFR 1.114. The reply must be filed within one of the following time periods:
a) The period for reply expires 3 months from the mailing date of the final rejection.
b) The period for reply expires on: (1) the mailing date of this Advisory Action, or (2) the date set forth in the final rejection, whichever is later. If no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of the final rejection.
Examiner Note: If box 1 is checked, check either box (a) or (b). ONLY CHECK BOX (b) WHEN THE FIRST REPLY WAS FILED WITHIN TW MONTHS OF THE FINAL REJECTION. See MPEP 706.07(f).
Extensions of time may be obtained under 37 CFR 1,138(a). The date on which the petition under 37 CFR 1,138(a) and the appropriate extension fee have been filed is the date for purposes of determining the period of extension and the corresponding amount of the fee. The appropriate extension fee have 53 CFR 1,17(a) is calculated from: (1) the expiration date of the shortened statutory period for reply originally set in the final Office action, or (2) a set forth in (b) above, if checked. Any reply received by the Office later than three months after the mailing date of the final rejection, even if timely filed may reduce any earmed patent term adjustment. See 37 CFR 1,704(b).
NOTICE OF APPEAL
2. The Notice of Appeal was filed on
<u>AMENDMENTS</u>
<ol> <li>The proposed amendment(s) filed after a final rejection, but prior to the date of filing a brief, will not be entered because         <ul> <li>(a) They raise new issues that would require further consideration and/or search (see NOTE below);</li> <li>(b) They raise the issue of new matter (see NOTE below);</li> </ul> </li> </ol>
(c) They rate the issue of rewinated (see NOTE below),     (c) They are not deemed to place the application in better form for appeal by materially reducing or simplifying the issues for appeal; and/or
(d) ☐ They present additional claims without canceling a corresponding number of finally rejected claims.  NOTE:, (See 37 CFR 1.116 and 41.33(a)).
4. The amendments are not in compliance with 37 CFR 1.121. See attached Notice of Non-Compliant Amendment (PTOL-324).  5. Applicant's reply has overcome the following rejection(s):
<ol> <li>Newly proposed or amended claim(s) would be allowable if submitted in a separate, timely filed amendment canceling the non-allowable claim(s).</li> </ol>
7.  ☐ For purposes of appeal, the proposed amendment(s): a) ☐ will not be entered, or b) ☐ will be entered and an explanation of how the new or amended claims would be rejected is provided below or appended.

Claim(s) allowed: none. Claim(s) objected to: 13

Claim(s) rejected: 1-12 and 14-24

Claim(s) withdrawn from consideration: none.

The status of the claim(s) is (or will be) as follows:

## AFFIDAVIT OR OTHER EVIDENCE

- 8. 🔲 The affidavit or other evidence filed after a final action, but before or on the date of filing a Notice of Appeal will not be entered because applicant failed to provide a showing of good and sufficient reasons why the affidavit or other evidence is necessary and was not earlier presented. See 37 CFR 1.116(e).
- 9. The affidavit or other evidence filed after the date of filing a Notice of Appeal, but prior to the date of filing a brief, will not be entered because the affidavit or other evidence failed to overcome all rejections under appeal and/or appellant fails to provide a showing a good and sufficient reasons why it is necessary and was not earlier presented. See 37 CFR 41.33(d)(1).
- 10. The affidavit or other evidence is entered. An explanation of the status of the claims after entry is below or attached.

## REQUEST FOR RECONSIDERATION/OTHER

- 11. X The request for reconsideration has been considered but does NOT place the application in condition for allowance because: See Continuation Sheet.
- 12. Note the attached Information Disclosure Statement(s). (PTO/SB/08) Paper No(s). 13. Other:

/Matthew C. Landau/

Supervisory Patent Examiner, Art Unit 2813

Continuation of 11. does NOT place the application in condition for allowance because: Applicant argues that Yoshida fails to teach:including the step of "impregnating the pores of the electric

conductor with a semiconductor layer-forming precursor before energization to render the concentration of semiconductor layer-forming precursor in the electrolytic solution, "Hen that of semiconductor layer-forming precursor in the electrolytic solution," where Examiner notes that the transitional term "comprising", which is synonymous with "including," "containing," or "characterized by," is inclusive or open-ended and does not exclude additional, unrecited elements or method steps. See, e.g., 2- Mars Inc. v. H. J. Heinz Co., 377 at 1369, 1376, "I USPO2d 1837, 1843 [Fed. Cir. 2004] ("like the term comprising," the terms containing and mixture" are open-ended"),'s Invitrogen Corp. v. Biocrest Mig., L.P., 327 F., 3184, 1386, 1364, 1386, 1364 (Fed. Cir. 2003) ("The transition comprising in method claim indicates that the claim is open-ended and allows for additional steps."), Genentech, Inc. v. Chiron Corp., 112 F.34 495, 501, 42 USPO2d 1603, 1613 (Fed. Cir. 1977), Yoshida et al. discloses forming a semiconductive layer using two processes : chemical oxidion polymerization polymerization and electrolytic oxidative polymerization; both processes use a semiconducter leyer forming precursor of 3,4-ethylenedioxythiophene. The solution of the first process has a higher concentration (3 of precursor in 800 g of solution (10060)[07 3,4-ethylenedioxythiophene than the electrolytic oxidation solution (10 g of precursor in 600 g of solution (10060)[07 3,4-ethylenedioxythiophene than the electrolytic oxidation solution (10 g of precursor in 600 g of solution (10061)] before energization (10062). Furthermore with regards to claim 2 Yoshida teaches an electrolytic solution not containing a semiconductor layer. Therefore the pores are impregnated with a higher concentration of semiconductor precursor (10661) than that of the electrolytic solution not containing a semiconductor layer. Therefore the pores are impregnated with a higher concentration of semiconductor precursor in gong managemen steps and general para [0039] using